

# PMEG050T150EPD

50V, 15 A low VF Trench MEGA Schottky barrier rectifier
27 June 2016 Product data sheet

### 1. General description

Trench Maximum Efficiency General Application (MEGA) Schottky barrier rectifier, encapsulated in a CFP15 (SOT1289) power and flat lead Surface-Mounted Device (SMD) plastic package.

#### 2. Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 15 A
- Reverse voltage: V<sub>R</sub> ≤ 50 V
- · Low forward voltage
- Low leakage current due to Trench MEGA Schottky technology
- High power capability due to clip-bonding technology and heat sink
- Small and thin SMD power plastic package, typical height 0.78 mm
- AEC-Q101 qualified

## 3. Applications

- High efficiency DC-to-DC conversion
- · Switch mode power supply
- · Freewheeling application
- · Reverse polarity protection
- · Low power consumption application

#### 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$I_{F(AV)}$	average forward current	square wave; $\delta$ = 0.5 ; f = 20 kHz; $T_{sp} \le 145$ °C	-	-	15	Α
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C	-	-	50	V
V <sub>F</sub>	forward voltage	$I_F$ = 15 A; $t_p \le 300 \ \mu s$ ; δ ≤ 0.02 ; $T_j$ = 25 °C; pulsed	-	480	550	mV
I <sub>R</sub>	reverse current	$V_R$ = 10 V; $t_p \le 3$ ms; $\delta \le 0.03$ ; $T_j$ = 25 °C; pulsed	-	16	50	μΑ
		$V_R$ = 50 V; $t_p \le 3$ ms; $\delta \le 0.03$ ; $T_j$ = 25 °C; pulsed	-	34	100	μΑ



# 5. Pinning information

#### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	А	anode		⊬ <mark>F</mark> M ⊢A
2	А	anode		A aaa-009063
3	K	cathode	2	add 000000
			CFP15 (SOT1289)	

# 6. Ordering information

#### **Table 3. Ordering information**

Type number	Package				
	Name	Description	Version		
PMEG050T150EPD	CFP15	plastic, thermal enhanced ultra thin SMD package; 3 leads; body: 5.8 x 4.3 x 0.78 mm	SOT1289		

## 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PMEG050T150EPD	050T U15E

## 8. Limiting values

#### **Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C		-	50	V
I <sub>F</sub>	forward current	T <sub>sp</sub> = 140 °C; δ = 1		-	21	Α
I <sub>F(AV)</sub>	average forward current	square wave; $\delta$ = 0.5 ; f = 20 kHz; $T_{sp} \le$ 145 °C		-	15	А
I <sub>FSM</sub>	non-repetitive peak forward current	square wave; $t_p$ = 8 ms; $T_{j(init)}$ = 25 °C		-	210	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	1.66	W
			[2]	-	2.15	W
			[3]	-	3.5	W
Tj	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint. Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

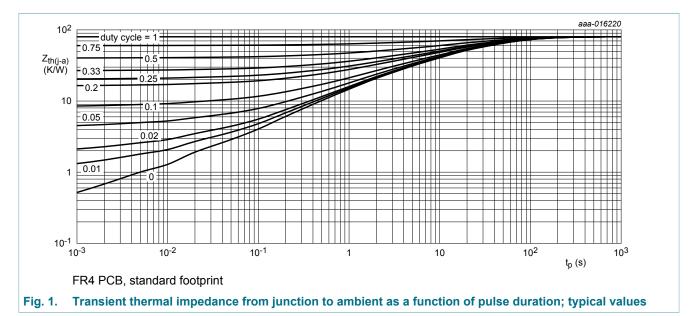
Device mounted on a ceramic Printed-Circuit Board (PCB), Al<sub>2</sub>O<sub>3</sub>, standard footprint.

#### 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance	in free air	[1][2]	-	-	90	K/W
	from junction to ambient		[1][3]	-	-	70	K/W
			[1][4]	-	-	42	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		<u>[5]</u>	-	-	3	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [5] Soldering point of cathode tab.



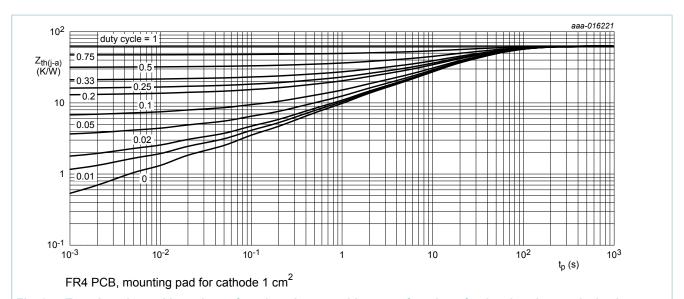


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

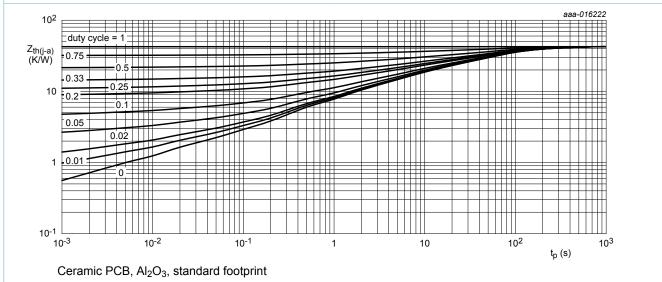


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

### 10. Characteristics

#### **Table 7. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R = 5 \text{ mA}; T_j = 25 \text{ °C}; t_p \le 1.2 \text{ ms};  \delta \le 0.12; \text{ pulsed}$	50	-	-	V
V <sub>F</sub>	forward voltage	$I_F$ = 1 A; $t_p \le 300 \ \mu s$ ; $\delta \le 0.02$ ; $T_j$ = 25 °C; pulsed	-	320	380	mV
		$I_F = 5 \text{ A}; t_p \le 300 \mu\text{s}; \delta \le 0.02 ;$ $T_j = 25 \text{ °C}; \text{ pulsed}$	-	390	460	mV
		$I_F$ = 10 A; $t_p \le 300 \ \mu s$ ; $\delta \le 0.02$ ; $T_j$ = 25 °C; pulsed	-	440	-	mV
		$I_F$ = 15 A; $t_p \le 300 \ \mu s$ ; δ ≤ 0.02 ; $T_j$ = 25 °C; pulsed	-	480	550	mV
		$I_F$ = 15 A; $t_p \le 300 \ \mu s$ ; δ ≤ 0.02 ; $T_j$ = 125 °C; pulsed	-	405	-	mV
I <sub>R</sub>	reverse current	$V_R = 5 \text{ V}; t_p \le 3 \text{ ms}; \delta \le 0.03 ;$ $T_j = 25 \text{ °C}; \text{ pulsed}$	-	12	-	μA
		$V_R$ = 10 V; $t_p \le 3$ ms; $\delta \le 0.03$ ; $T_j$ = 25 °C; pulsed	-	16	50	μA
		$V_R$ = 50 V; $t_p \le 3$ ms; $\delta \le 0.03$ ; $T_j$ = 25 °C; pulsed	-	34	100	μA
		$V_R$ = 50 V; $t_p \le 3$ ms; $\delta \le 0.03$ ; $T_j$ = 125 °C; pulsed	-	22	-	mA
C <sub>d</sub>	diode capacitance	$V_R = 1 \text{ V}; f = 1 \text{ MHz}; T_j = 25 \text{ °C}$	-	2200	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	800	-	pF
t <sub>rr</sub>	reverse recovery time step recovery	$I_F = 0.5 \text{ A}$ ; $I_R = 1 \text{ A}$ ; $I_{R(meas)} = 0.25 \text{ A}$ ; $T_j = 25 \text{ °C}$	-	60	-	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}$	-	305	-	mV

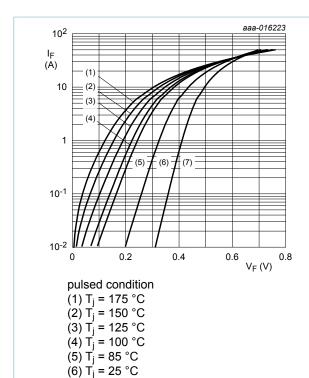


Fig. 4. Forward current as a function of forward voltage; typical values

 $(7) T_i = -40 ^{\circ}C$ 

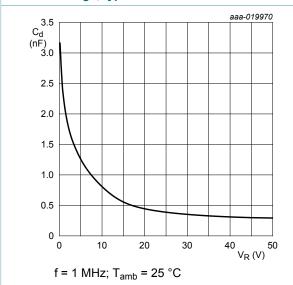


Fig. 6. Diode capacitance as a function of reverse voltage; typical values

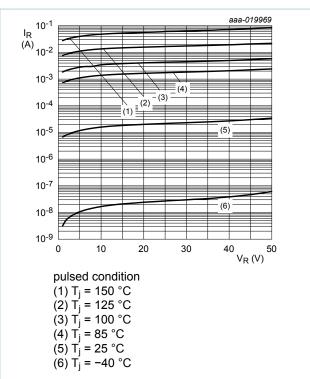
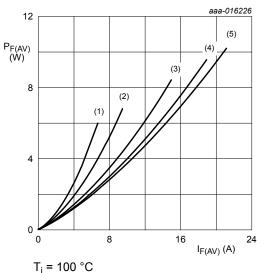


Fig. 5. Reverse current as a function of reverse voltage; typical values



 $T_j = 100 \,^{\circ}\text{C}$   $(1) \, \bar{\delta} = 0.1$   $(2) \, \bar{\delta} = 0.2$   $(3) \, \bar{\delta} = 0.5$   $(4) \, \bar{\delta} = 0.8$  $(5) \, \bar{\delta} = 1$ 

Fig. 7. Average forward power dissipation as a function of average forward current; typical values

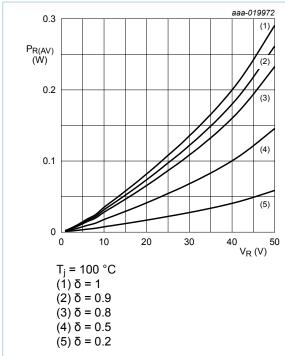
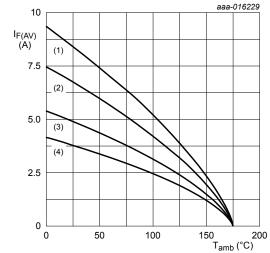


Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, mounting pad for cathode 1  $\mathrm{cm}^2$ 

 $T_j = 175 \,{}^{\circ}\text{C}$ 

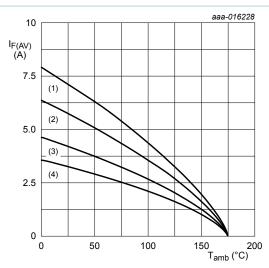
 $(1) \delta = 1; DC$ 

(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta$  = 0.1; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



FR4 PCB, standard footprint

 $T_i = 175 \,{}^{\circ}\text{C}$ 

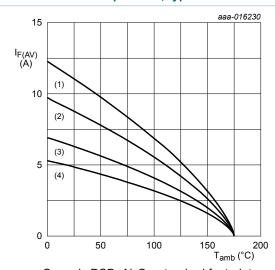
 $(1) \delta = 1; DC$ 

(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta$  = 0.1; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint

T<sub>i</sub> = 175 °C

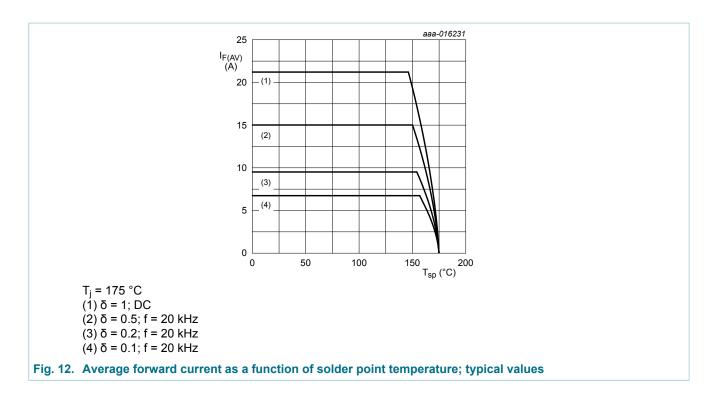
 $(1) \delta = 1; DC$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

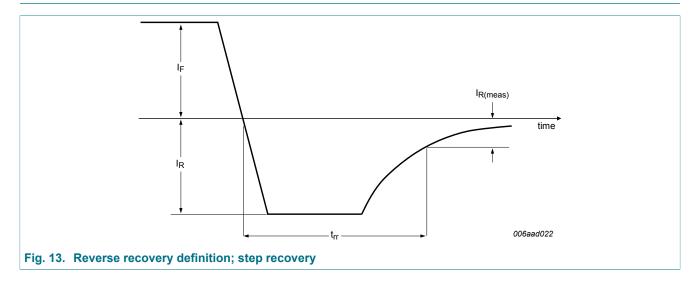
(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta$  = 0.1; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



## 11. Test information



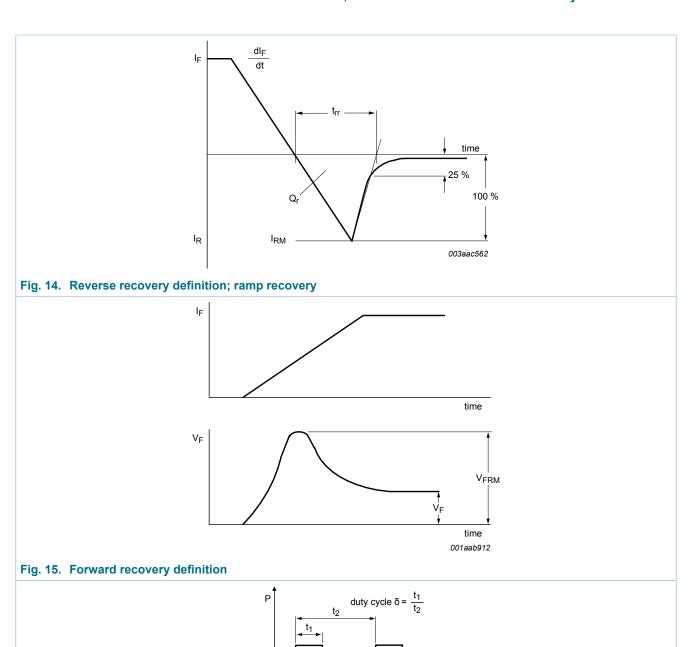


Fig. 16. Duty cycle definition

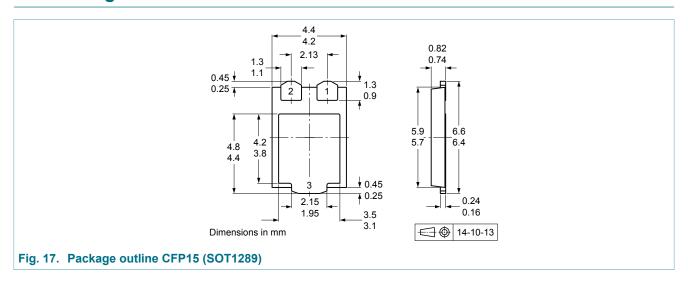
The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_{M} \times \delta$  with  $I_{M}$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_{M} \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

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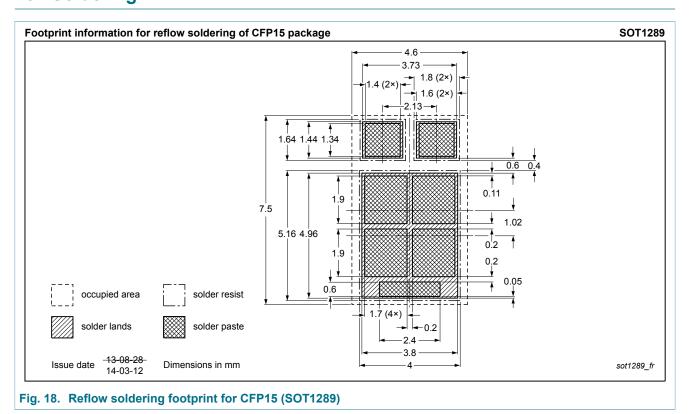
#### **Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

## 12. Package outline



## 13. Soldering



# 14. Revision history

#### Table 8. Revision history

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Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG050T150EPD v.3	20160627	Product data sheet	-	PMEG050T150EPD v.2
Modification:	Section 7: Mar	king code corrected		
PMEG050T150EPD v.2	20151218	Product data sheet	-	PMEG050T150EPD v.1
PMEG050T150EPD v.1	20150930	Preliminary data sheet		

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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### 16. Contents

1.	General description	1
2.	Features and benefits	1
3.	Applications	1
4.	Quick reference data	1
5.	Pinning information	2
6.	Ordering information	2
7.	Marking	2
8.	Limiting values	3
9.	Thermal characteristics	4
10.	. Characteristics	е
11.	. Test information	g
12.	. Package outline	11
13.	Soldering	11
	. Revision history	
	Legal information	

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